# Low phase noise LO generator for VSAT applications

Rev. 1 — 28 March 2013

**Product data sheet** 

# 1. General description

The TFF11092HN is a  $K_u$  band frequency generator intended for low phase noise Local Oscillator (LO) circuits for  $K_u$  band VSAT transmitters and transceivers. The specified phase noise complies with IESS-308 from Intelsat.

### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

## 2. Features and benefits

- Phase noise compliant with IESS-308 (Intelsat) in combination with appropriate source
- LO generator with VCO range from 9.03 GHz to 9.22 GHz
- Input signal 35 MHz to 576 MHz
- Divider settings 16, 32, 64, 128 or 256
- Output level –3 dBm; stability ±2 dB
- Third or fourth order PLL
- Internally stabilized voltage references for loop filter

# 3. Applications

VSAT up converters

Local oscillator signal generation

### 4. Quick reference data

# Table 1.Quick reference dataOperating conditions of Table 10 apply.

| 1 0                             | <u> </u>                       |  |      |     |      |        |
|---------------------------------|--------------------------------|--|------|-----|------|--------|
| Symbol                          | Parameter                      | Conditions   | Min  | Тур | Max  | Unit   |
| V <sub>CC</sub>                 | supply voltage                 |  | 3.0  | 3.3 | 3.6  | V      |
| I <sub>CC</sub>                 | supply current                 |  | -    | 100 | 130  | mA     |
| f <sub>o(RF)</sub>              | RF output frequency            |  | 9.03 | -   | 9.22 | GHz    |
| $\phi_{\text{n}(\text{synth})}$ | synthesizer phase noise        | divider value = 64; at 100 kHz offset; reference<br>phase noise is -149 dBc/Hz at 100 kHz offset | -    | -97 | -92  | dBc/Hz |
| RL <sub>out</sub>               | output return loss             | measured at demo board and de-embedded to footprint  | -    | -10 | -    | dB     |
| $\alpha_{sup(sp)ref}$           | reference spurious suppression | measured at divider value = 256  | -    | -   | -70  | dBc    |
|                                 |                                |  |      |     |      |        |



Low phase noise LO generator for VSAT applications

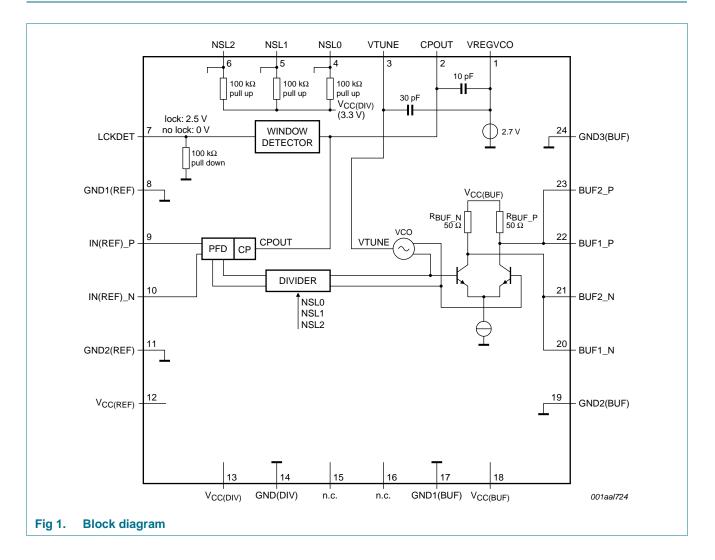
# 5. Ordering information

| Table 2.         Ordering information |         |  |          |  |  |
|---------------------------------------|---------|--|----------|--|--|
| Type number                           | Package |  |          |  |  |
|                                       | Name    | Description  | Version  |  |  |
| TFF11092HN                            | HVQFN24 | plastic thermal enhanced very thin quad flat package; no leads; 24 terminals; body $4 \times 4 \times 0.85$ mm | SOT616-1 |  |  |

# 6. Marking

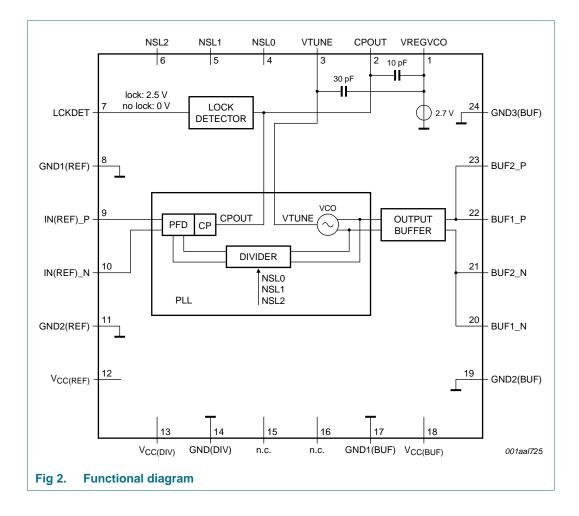
| Table 3.   Marking codes |              |
|--------------------------|--------------|
| Type number              | Marking code |
| TFF11092HN               | T092         |

# 7. Block diagram



### Low phase noise LO generator for VSAT applications

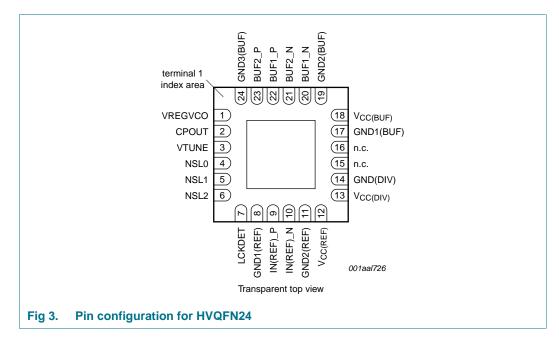
# 8. Functional diagram



Low phase noise LO generator for VSAT applications

# 9. Pinning information

### 9.1 Pinning



### 9.2 Pin description

| Symbol               | Pin | Description  |
|----------------------|-----|--|
| VREGVCO              | 1   | Regulated output voltage for VCO loop filter. Connect loop filter to this pin.           |
| CPOUT                | 2   | Charge pump output.  |
| VTUNE                | 3   | Tuning voltage for VCO.  |
| NSL0                 | 4   | Divider setting, LSB. Leave open for "1", connect to GND for "0". See <u>Table 8</u> .   |
| NSL1                 | 5   | Divider setting. Leave open for "1", connect to GND for "0". See <u>Table 8</u> .        |
| NSL2                 | 6   | Divider setting, MSB. Leave open for "1", connect to GND for "0". See Table 8.           |
| LCKDET               | 7   | Lock detect. Lock = 2.5 V; out of lock = 0 V. See <u>Table 6</u> .                       |
| GND1(REF)            | 8   | Ground for REF input. Connect this pin to the exposed diepad landing.                    |
| IN(REF)_P            | 9   | Reference signal, non-inverting input. Couple this AC to the source.                     |
| IN(REF)_N            | 10  | Reference signal, inverting input. Couple this AC to the source.                         |
| GND2(REF)            | 11  | Ground for REF input. Connect this pin to the exposed diepad landing.                    |
| $V_{CC(REF)}$        | 12  | Supply of the internal regulated voltages. Decouple this pin against GND2(REF) (pin 11). |
| V <sub>CC(DIV)</sub> | 13  | Supply of the divider and PFD/CP. Decouple this pin against GND(DIV) (pin 14).           |
| GND(DIV)             | 14  | Ground of the divider. Connect this pin to the exposed diepad landing.                   |
| n.c.                 | 15  | not connected  |
| n.c.                 | 16  | not connected  |
| GND1(BUF)            | 17  | Ground for RF output. Connect this pin to the exposed diepad landing.                    |

All information provided in this document is subject to legal disclaimers.

TFF11092HN

### Low phase noise LO generator for VSAT applications

| Table 4.             | Pin de | scriptioncontinued   |
|----------------------|--------|--|
| Symbol               | Pin    | Description  |
| V <sub>CC(BUF)</sub> | 18     | Supply voltage for the RF output buffer. Decouple this pin against GND2(BUF) (pin 19). |
| GND2(BUF)            | 19     | Ground for RF output. Connect this pin to the exposed diepad landing.                  |
| BUF1_N               | 20     | RF output.   |
| BUF2_N               | 21     | RF output.   |
| BUF1_P               | 22     | RF output.   |
| BUF2_P               | 23     | RF output.   |
| GND3(BUF)            | 24     | Ground for RF output. Connect this pin to the exposed diepad landing.                  |

# **10. Functional description**

The TFF11092HN consists of the following blocks:

- PLL
- Output buffer
- Lock detector
- Reference input
- Divider settings

The functionality of the blocks will be discussed below.

### 10.1 PLL

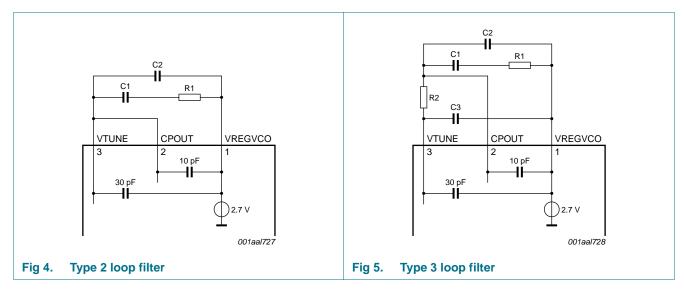
The PLL is formed by the VCO, DIVIDER (possible settings: 16, 32, 64, 128 and 256 (see <u>Table 8</u>)) and a PFD/CP. The tune voltage is referred to the band gap regulated voltage: VREGVCO (pin 1).

The loop filter can be set to type 2 or type 3. If a type 2 filter is used, the pins CPOUT (pin 2) and VTUNE (pin 3) must be interconnected. A 10 pF capacitor is placed internally between pins CPOUT (pin 2) and VREGVCO (pin 1), and a 30 pF capacitor is placed between pins VTUNE (pin 3) and VREGVCO (pin 1). See <u>Figure 4</u> and <u>Figure 5</u>. Values for the loop filter components are given in Table 5.

The VCO input voltage range is between 0.1 and 0.9  $V_{O(reg)VCO}$ .

# **TFF11092HN**

### Low phase noise LO generator for VSAT applications



### Table 5. Component values used for characterization

| f <sub>i(ref)</sub> | Divider value | C1   | C2   | C3   | R1  | R2  |
|---------------------|---------------|------|------|------|-----|-----|
| (MHz)               |               | (nF) | (pF) | (pF) | (Ω) | (Ω) |
| 35.273 to 36.016    | 256           | 27   | 82   | 33   | 470 | 560 |
| 70.547 to 72.031    | 128           | 18   | 82   | 33   | 330 | 560 |
| 141.094 to 144.063  | 64            | 18   | 120  | 33   | 270 | 560 |
| 282.188 to 288.125  | 32            | 33   | 270  | 33   | 120 | 560 |
| 564.375 to 576.250  | 16            | 68   | 560  | 33   | 68  | 560 |

### 10.2 Output buffer

The output consists of a differential pair with 50  $\Omega$  collector resistors R<sub>BUF\_P</sub> and R<sub>BUF\_N</sub>. If only one output is used, terminate the non used output with the same impedance as the load (see Figure 8)

### 10.3 Lock detector

The lock detector is the output of a window detector. The window detector compares the output voltage over the charge pump. This voltage is identical to VTUNE when a type 2 loop filter is used (see <u>Figure 4</u>). In case of a type 3 loop filter this voltage is filtered by R2/C3 (see <u>Figure 5</u>). Due to this filtering the attack and decay time will decrease.

The lower window detector threshold voltage is 7 % of the output voltage on VREGVCO (pin 1), the upper window detector threshold voltage is 93 % of the output voltage on VREGVCO (pin 1). The hysteresis is 0.1 V. The output is 2.5 V CMOS compliant. The values are shown in <u>Table 6</u>. The timing diagram is shown in <u>Figure 6</u>.

At start-up the LCKDET (pin 7) will be LOW until the circuit has acquired lock.

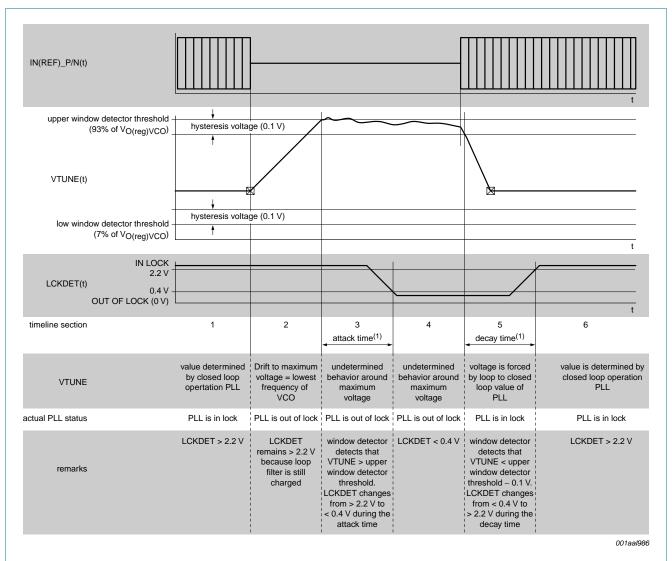
# **TFF11092HN**

### Low phase noise LO generator for VSAT applications

 Table 6.
 Logical value and physical value for lock detect (LCKDET)

| Logical value | Physical value | Lock detect state |
|---------------|----------------|-------------------|
| 0             | 0 V            | out of lock       |
| 1             | 2.5 V          | lock              |

LCKDET (pin 7) has a pull-down resistor of 100 k $\Omega$  to GND1(REF) (pin 8).



(1) The attack time and decay time are typically 10 µs and are mainly depending on the drift of the VCO tuning voltage.

Fig 6. Timing diagram lock detector

### 10.4 Reference input (IN(REF)\_P, IN(REF)\_N)

The reference input is a differential pair and is internally biased. The input is high ohmic. The input signal must be AC coupled. If used in a single ended mode, the not used input must be terminated with the same impedance as the driving source.

An example of the differential source and two single ended loads are shown in <u>Figure 7</u>. An example of a single ended application is shown in <u>Figure 8</u>.

All information provided in this document is subject to legal disclaimers.

TFF11092HN

7 of 17

### Low phase noise LO generator for VSAT applications

Note that the phase noise of the output signal is also determined by the phase noise of the reference signal. The reference frequency range is equal to the output frequency / division value. Note that the output frequency is guaranteed from 8.20 GHz to 8.60 GHz.

### 10.5 Divider settings (NSL2, NSL1, NSL0)

The divider can be set to 16, 32, 64, 128 and 256 (See Table 8). The logic levels for NSL0 (pin 4), NSL1 (pin 5) and NSL2 (pin 6) are given in Table 7.

The pins have a pull-up resistor of 100 k $\Omega$  to V<sub>CC(DIV)</sub> (pin 13).

The device is only guaranteed when NSL2, NSL1 and NSL0 are predefined at start-up (no change of divider value is allowed during operation).

### Table 7. Logical and physical value for divider setting (NSL2, NSL1, NSL0)

| Logical value | Physical value          |
|---------------|-------------------------|
| 0             | GND                     |
| 1             | open or V <sub>CC</sub> |

The truth table is shown in Table 8.

### Table 8. Divider setting as function of NSL2, NSL1 and NSL0

| Setting number | NSL2 | NSL1 | NSL0 | Divider value |
|----------------|------|------|------|---------------|
| 0              | 0    | 0    | 0    | 16            |
| 1              | 0    | 0    | 1    | 32            |
| 2              | 0    | 1    | 0    | 64            |
| 3              | 0    | 1    | 1    | 128           |
| 4              | 1    | 0    | 0    | 256           |
| 5              | 1    | 0    | 1    | [1]           |
| 6              | 1    | 1    | 0    | [1]           |
| 7              | 1    | 1    | 1    | <u>[1]</u>    |

[1] Test mode, divider output will be disabled.

### 11. Limiting values

### Table 9. **Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter     | Conditions           | Min  | Мах | Unit |
|--------|---------------|----------------------|------|-----|------|
| VI     | input voltage | on pin NSL0          | -0.5 | +5  | V    |
|        | on pin NSL1   | on pin NSL1          | -0.5 | +5  | V    |
|        |               | on pin NSL2          | -0.5 | +5  | V    |
|        |               | on pin IN(REF)_P     | -0.5 | +5  | V    |
|        |               | on pin IN(REF)_N     | -0.5 | +5  | V    |
|        |               | on pin $V_{CC(REF)}$ | -0.5 | +5  | V    |
|        |               | on pin $V_{CC(DIV)}$ | -0.5 | +5  | V    |
|        |               | on pin $V_{CC(BUF)}$ | -0.5 | +5  | V    |

TFF11092HN

### Low phase noise LO generator for VSAT applications

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol           | Parameter                       | Conditions   | Min | Max  | Unit |
|------------------|---------------------------------|--|-----|------|------|
| Pi               | input power                     | on pin IN(REF)_P   | -4  | +10  | dBm  |
|                  |                                 | on pin IN(REF)_N   | -4  | +10  | dBm  |
| Tj               | junction temperature            |  | -40 | +125 | °C   |
| T <sub>stg</sub> | storage temperature             |  | -40 | +125 | °C   |
| V <sub>ESD</sub> | electrostatic discharge voltage | Human Body Model (HBM);<br>According JEDEC standard<br>22-A114E        | -   | 2.5  | kV   |
|                  |                                 | Charged Device Model (CDM);<br>According to JEDEC standard<br>22-C101B | -   | 1    | kV   |

# **12. Recommended operating conditions**

### Table 10. Operating conditions

NSL0 (pin 4), NSL1 (pin 5) and NSL2 (pin 6) not changed during operation. Loop filter component values as depicted in Table 5 are used.

| ,                   | , ,                       |  |     |     |     |      |        |
|---------------------|---------------------------|--|-----|-----|-----|------|--------|
| Symbol              | Parameter                 | Conditions                               |     | Min | Тур | Max  | Unit   |
| T <sub>amb</sub>    | ambient temperature       |  |     | -40 | +25 | +85  | °C     |
| Z <sub>0</sub>      | characteristic impedance  |  |     | -   | 50  | -    | Ω      |
| φn(ref)             | reference phase noise     | divider value = 16                       | [1] | -   | -   | -134 | dBc/Hz |
|                     |                           | divider value = 32                       | [1] | -   | -   | -143 | dBc/Hz |
|                     |                           | divider value = 64                       | [1] | -   | -   | -149 | dBc/Hz |
|                     |                           | divider value = 128                      | [1] | -   | -   | -150 | dBc/Hz |
|                     |                           | divider value = 256                      | [1] | -   | -   | -151 | dBc/Hz |
| f <sub>i(ref)</sub> | reference input frequency | $f_{i(ref)} = f_{o(RF)} / divider value$ |     | 35  | -   | 576  | MHz    |
| P <sub>i(ref)</sub> | reference input power     |  |     | -10 | -   | 0    | dBm    |

[1] Required reference phase noise is set 10 dB below equivalent input phase noise.

## 13. Thermal characteristics

| Table 11.             | Thermal characteristics                          |            |     |      |
|-----------------------|--|------------|-----|------|
| Symbol                | Parameter  | Conditions | Тур | Unit |
| R <sub>th(j-sp)</sub> | thermal resistance from junction to solder point |            | 25  | K/W  |

Low phase noise LO generator for VSAT applications

# 14. Characteristics

### Table 12. Characteristics

Operating conditions of <u>Table 10</u> apply.

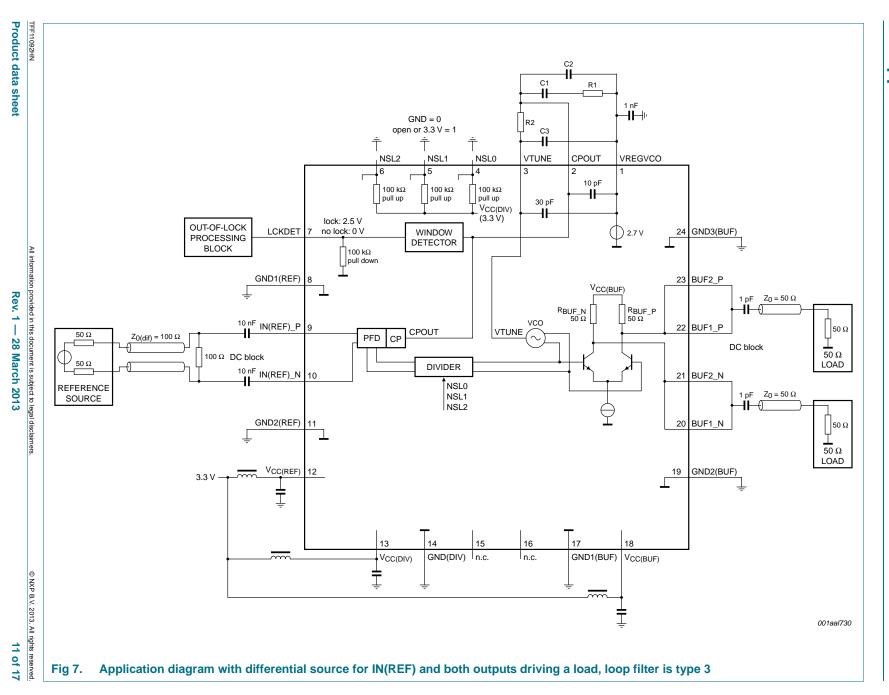
|                        |                                | O an dition a   |     | N.4.1 | <b>T</b> |      | 11     |
|------------------------|--------------------------------|---|-----|-------|----------|------|--------|
| Symbol                 | Parameter                      | Conditions  |     | Min   | Тур      | Мах  | Unit   |
| V <sub>CC</sub>        | supply voltage                 |   |     | 3.0   | 3.3      | 3.6  | V      |
| I <sub>CC</sub>        | supply current                 |   |     | -     | 100      | 130  | mA     |
| PLL                    |                                |   |     |       |          |      |        |
| f <sub>o(RF)</sub>     | RF output frequency            |   |     | 9.03  | -        | 9.22 | GHz    |
| V <sub>O(reg)VCO</sub> | VCO regulator output voltage   |   |     | 2.5   | 2.7      | 2.9  | V      |
| I <sub>cp</sub>        | charge pump current            |   |     | -     | 1        | -    | mA     |
| Ko                     | VCO steepness                  |   | [1] | -     | 0.48     | -    | GHz/V  |
| Φn(VCO)                | VCO phase noise                | at 10 MHz offset  |     | -     | -130     | -    | dBc/Hz |
| φn(synth)              | synthesizer phase noise        | divider value = 64; at 100 kHz<br>offset; reference phase noise is<br>–149 dBc/Hz at 100 kHz offset |     | -     | -97      | -92  | dBc/Hz |
| Output buff            | er                             |   |     |       |          |      |        |
| Po                     | output power                   | measured single ended   | [2] | -5    | -        | -1   | dBm    |
| RL <sub>out</sub>      | output return loss             | measured at demo board and<br>de-embedded to footprint  |     | -     | -10      | -    | dB     |
| $\alpha_{sup(sp)ref}$  | reference spurious suppression | measured at divider value = 256   |     | -     | -        | -70  | dBc    |
| $\alpha_{H(LO)}$       | LO harmonic rejection          |   |     | -     | -10      | -    | dBc    |
| Lock detect            | tor                            |   |     |       |          |      |        |
| V <sub>OL</sub>        | LOW-level output voltage       | I <sub>O</sub> = 1 mA   |     | -     | -        | 0.4  | V      |
| V <sub>OH</sub>        | HIGH-level output voltage      | $I_O = -1 \text{ mA}$   |     | 2.2   | -        | -    | V      |
| R <sub>pd</sub>        | pull-down resistance           |   |     | 70    | 100      | 130  | kΩ     |
|                        | ing (NSL0, NSL1, NSL2)         |   |     |       |          |      |        |
| R <sub>pu</sub>        | pull-up resistance             |   |     | 70    | 100      | 130  | kΩ     |
| V <sub>IL</sub>        | LOW-level input voltage        |   |     | -     | -        | 0.8  | V      |
| V <sub>IH</sub>        | HIGH-level input voltage       |   |     | 2.0   | -        | -    | V      |
|                        |                                |   |     |       |          |      |        |

[2] Output stage is a differential pair with 50 Ω collector impedances.
 Output power is measured per output pin for the fundamental tone only.
 Output is DC coupled and is AC coupled in on-board.



Low phase noise LO generator for VSAT applications

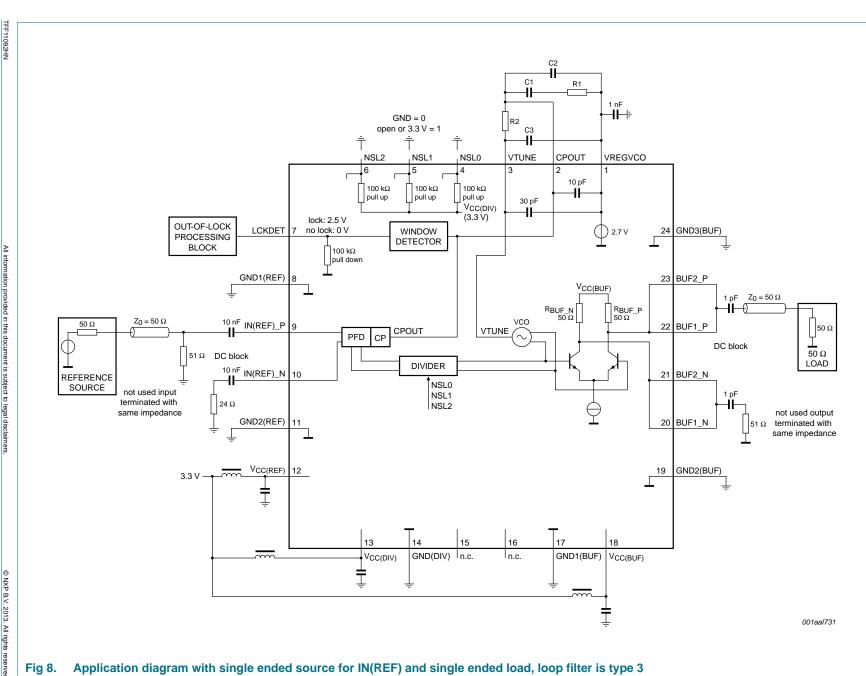
# **15. Application information**



Product data sheet

All information provided in this document is subject to legal disclaimers
Rev. 1 — 28 March 2013

© NXP B.V. 2013. All rights reserved. 12 of 17



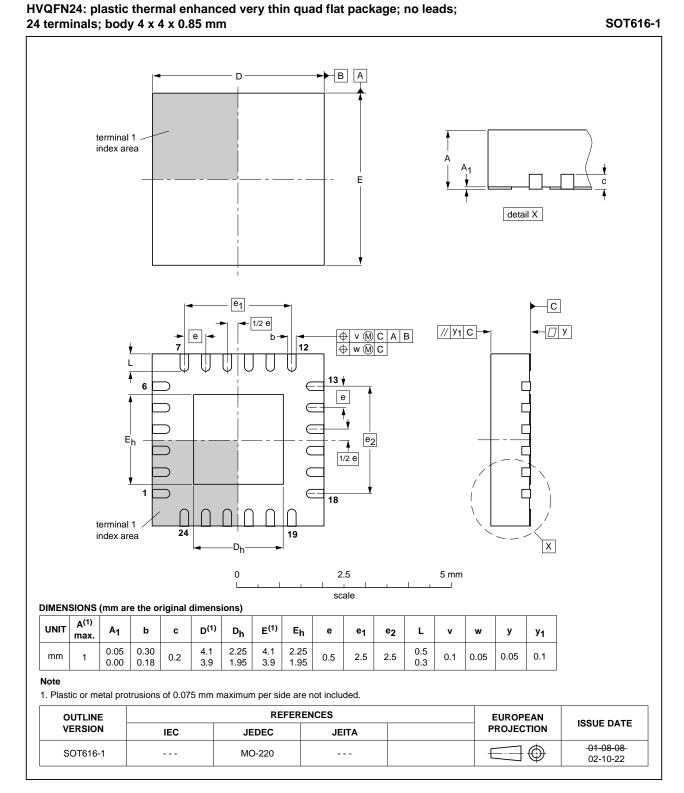
**NXP Semiconductors** 

**TFF11092HN**Low phase noise LO generator for VSAT applications

# **TFF11092HN**

Low phase noise LO generator for VSAT applications

# 16. Package outline



### Fig 9. Package outline SOT616-1 (HVQFN24)

All information provided in this document is subject to legal disclaimers.

TFF11092HN

### Low phase noise LO generator for VSAT applications

# **17. Abbreviations**

| Table 13.           | Abbreviations                           |
|---------------------|---|
| Acronym             | Description                             |
| CMOS                | Complementary Metal Oxide Semiconductor |
| CP                  | Charge Pump                             |
| K <sub>u</sub> band | K-under band                            |
| LSB                 | Least Significant Bit                   |
| MSB                 | Most Significant Bit                    |
| PFD                 | Phase Frequency Detector                |
| PLL                 | Phase-Locked Loop                       |
| VCO                 | Voltage Controlled Oscillator           |
| VSAT                | Very Small Aperture Terminal            |

# 18. Revision history

| Table 14. Revision history |              |                    |               |            |  |
|----------------------------|--------------|--------------------|---------------|------------|--|
| Document ID                | Release date | Data sheet status  | Change notice | Supersedes |  |
| TFF11092HN v.1             | 20130328     | Product data sheet | -             | -          |  |

### Low phase noise LO generator for VSAT applications

# **19. Legal information**

### **19.1 Data sheet status**

| Document status[1][2]          | Product status <sup>[3]</sup> | Definition  |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet   | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

### **19.2 Definitions**

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

**Product specification** — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

### 19.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof. Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product sole and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <a href="http://www.nxp.com/profile/terms">http://www.nxp.com/profile/terms</a>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

**No offer to sell or license** — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

© NXP B.V. 2013. All rights reserved.

TFF11092HN

### Low phase noise LO generator for VSAT applications

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

**Translations** — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

### 19.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

# **20. Contact information**

For more information, please visit: <u>http://www.nxp.com</u>

For sales office addresses, please send an email to: salesaddresses@nxp.com

# **TFF11092HN**

Low phase noise LO generator for VSAT applications

# 21. Contents

| 1    | General description 1                    |
|------|--|
| 2    | Features and benefits 1                  |
| 3    | Applications 1                           |
| 4    | Quick reference data 1                   |
| 5    | Ordering information 2                   |
| 6    | Marking 2                                |
| 7    | Block diagram 2                          |
| 8    | Functional diagram 3                     |
| 9    | Pinning information 4                    |
| 9.1  | Pinning                                  |
| 9.2  | Pin description                          |
| 10   | Functional description 5                 |
| 10.1 | PLL                                      |
| 10.2 | Output buffer                            |
| 10.3 | Lock detector 6                          |
| 10.4 | Reference input (IN(REF)_P, IN(REF)_N) 7 |
| 10.5 | Divider settings (NSL2, NSL1, NSL0)      |
| 11   | Limiting values 8                        |
| 12   | Recommended operating conditions 9       |
| 13   | Thermal characteristics 9                |
| 14   | Characteristics 10                       |
| 15   | Application information                  |
| 16   | Package outline                          |
| 17   | Abbreviations                            |
| 18   | Revision history 14                      |
| 19   | Legal information                        |
| 19.1 | Data sheet status 15                     |
| 19.2 | Definitions 15                           |
| 19.3 | Disclaimers                              |
| 19.4 | Trademarks 16                            |
| 20   | Contact information 16                   |
| 21   | Contents 17                              |
|      |  |

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

### © NXP B.V. 2013.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 28 March 2013 Document identifier: TFF11092HN